



Customer Information Notification

201308008I

Issue Date: 12-Aug-2013
Effective Date: 16-Aug-2013

Here's your personalized quality information concerning products from NXP.

For detailed information we invite you to [view this notification online](#)



QUALITY

Management Summary

Due to new internal rules 12NC was changed and at the same time errata were corrected.

Change Category

Wafer Fab process	Assembly Process	Product Marking	Design
Wafer Fab materials	Assembly Materials	Electrical spec./Test coverage	Mechanical Specification
Wafer Fab location	Assembly Location	Test Location	Packing/Shipping/Labeling

PCF85063TP 12nc ordering number and packing information correction

Information Notification

Due to new internal rules 12NC was changed and at the same time tape and reel details drawing errata were corrected in the datasheet. No changes to the dimensions defined. The new datasheet is attached.

Why do we issue this Information Notification

Regulation was changed which defines the numbering and naming of products.

Identification of Affected Products

Replacement part type created, see Parts Affected list

Impact

no impact to the product's functionality anticipated.

Data Sheet Revision

A new datasheet will be issued

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please [contact NXP "Global Quality Support Team"](#).

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Cengiz Oezcan
Position Quality Manager PL CWG
e-mail address cengiz.oezcan@nxp.com

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.
Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

A global semiconductor company with operations in more than 25 countries, NXP posted unaudited revenue of \$4.36 billion in 2012.

You have received this email because you are a designated contact or subscribed to NXP's Quality Notifications. NXP shall not be held liable if this Notification is not correctly distributed within your organization.

This message has been automatically distributed. Please do not reply.

[View Notification](#)

[Subscription](#)

[Support](#)

[NXP](#) | [Privacy Policy](#) | [Terms of Use](#)

NXP Semiconductors
High Tech Campus, 5656 AG Eindhoven, The Netherlands

© 2006-2010 NXP Semiconductors. All rights reserved.